

CFD-Thermal Interactions

Short Course, TFAWS 2003

Integrated Fluid-Thermal
Analysis from a Thermal-
Structures Perspective

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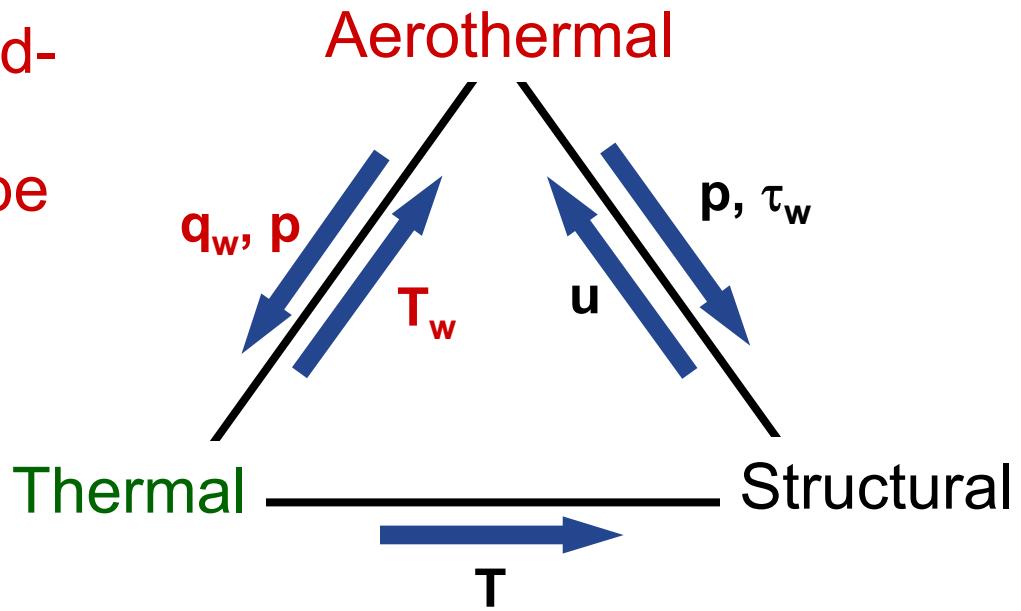
GWU M.S. Students

James Tomey, Ford Motor Company
Christopher Lang, MTSB LaRC
David Walker, ATK Thiokol



Integrated Fluid-Thermal Analysis for High Speed Flight Vehicles

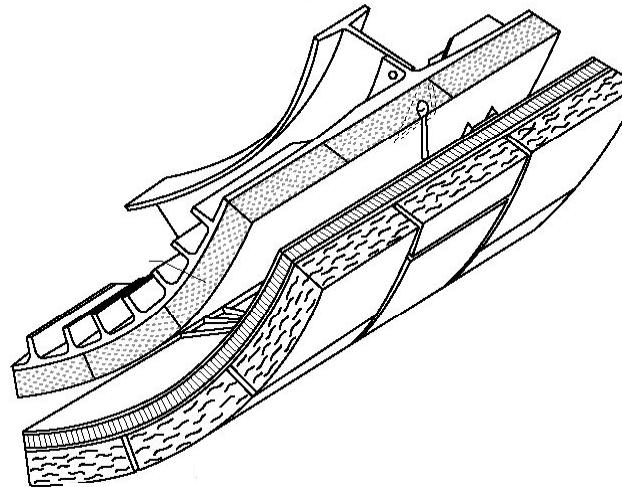
- Coupling at the fluid-thermal interface depends on the type of structure: insulated or non-insulated (hot)



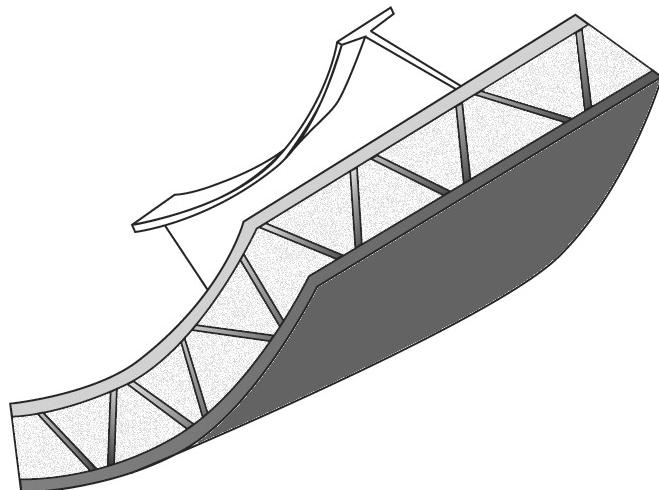
- “Next Generation” Thermal Analysis Methods for Hot Built-up Structures

Thermal-Structural Airframe Concepts for Reusable Launch Vehicles

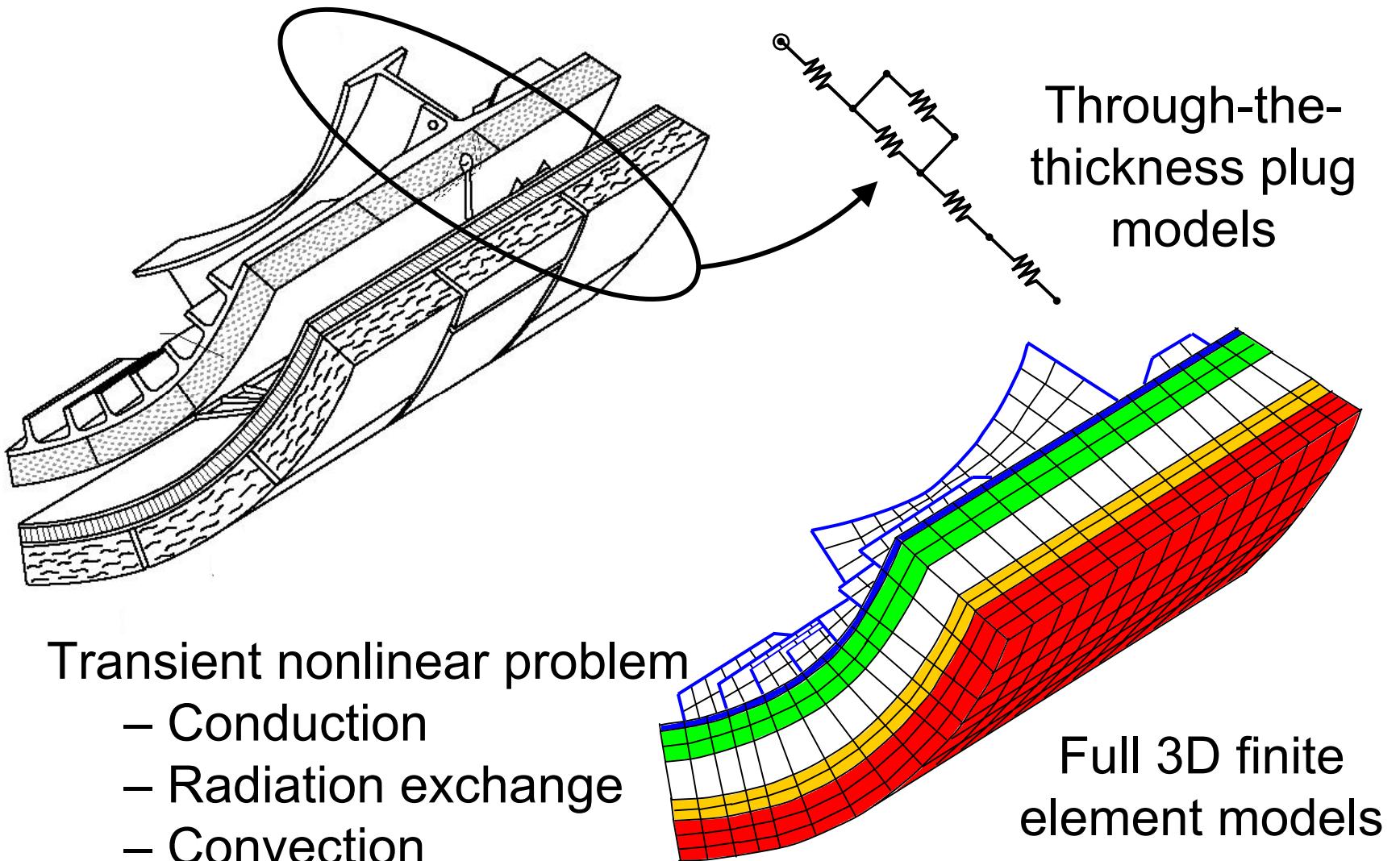
Cryotank with aeroshell and insulating thermal protection system



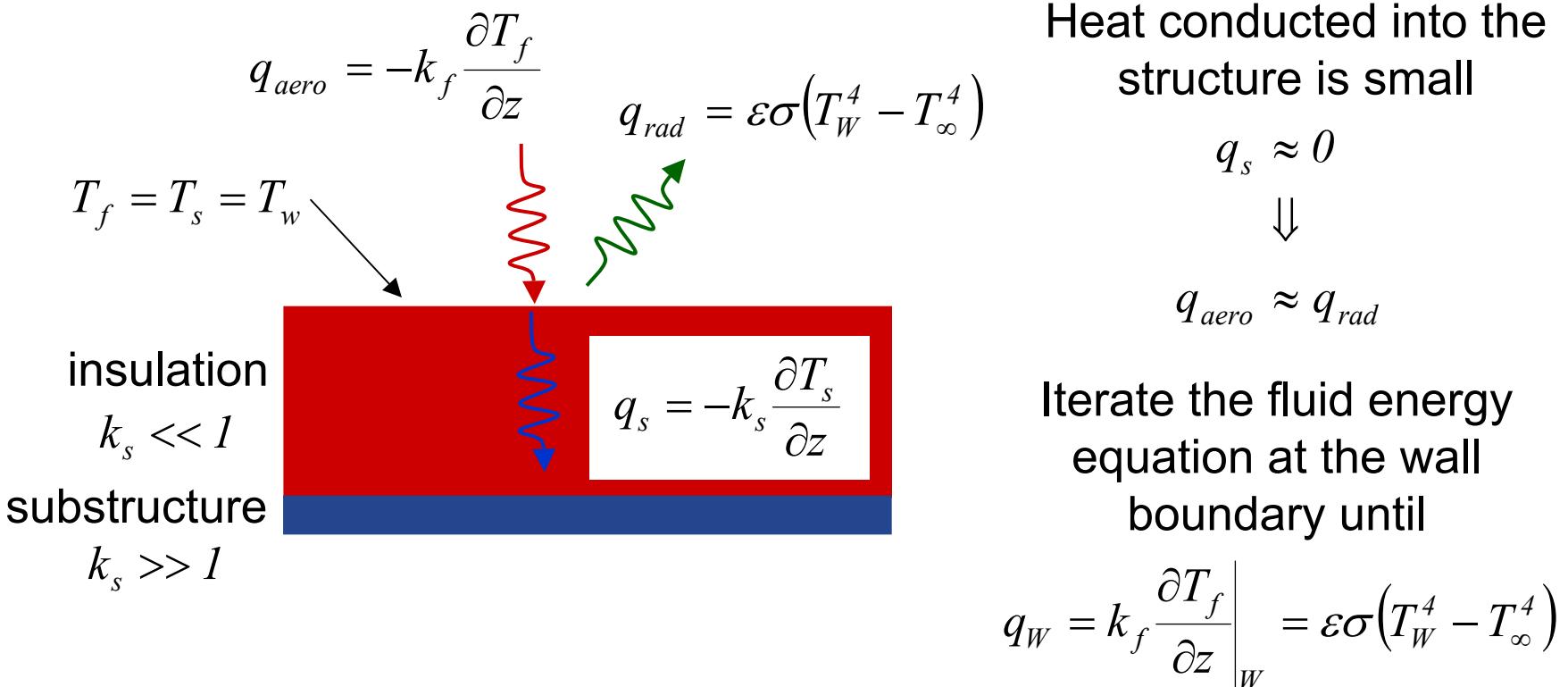
Integrated hot structure where thermal protection also carries load



Airframe Thermal Analysis State-of-the-Art



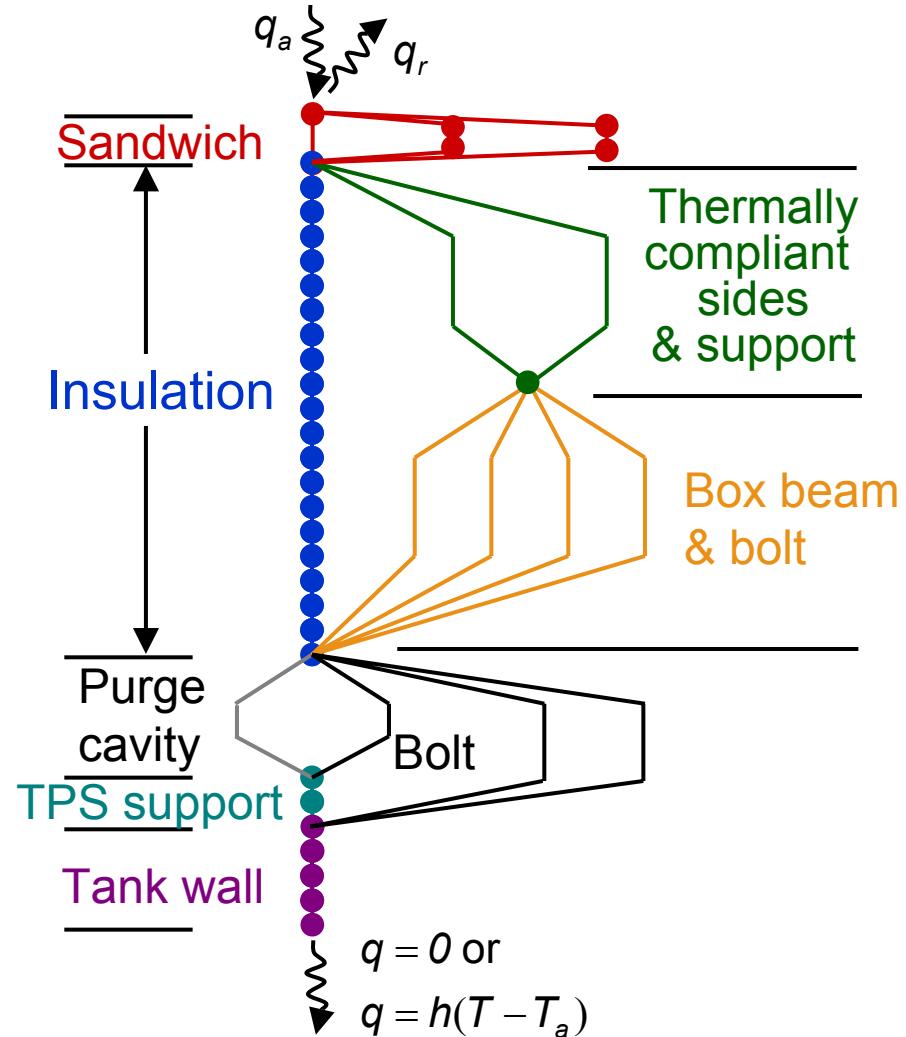
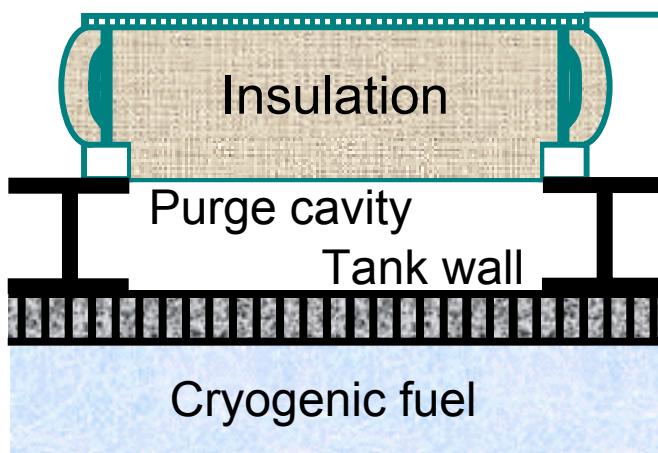
CFD-Thermal Interactions for Insulated Structures are (Approximately) Decoupled



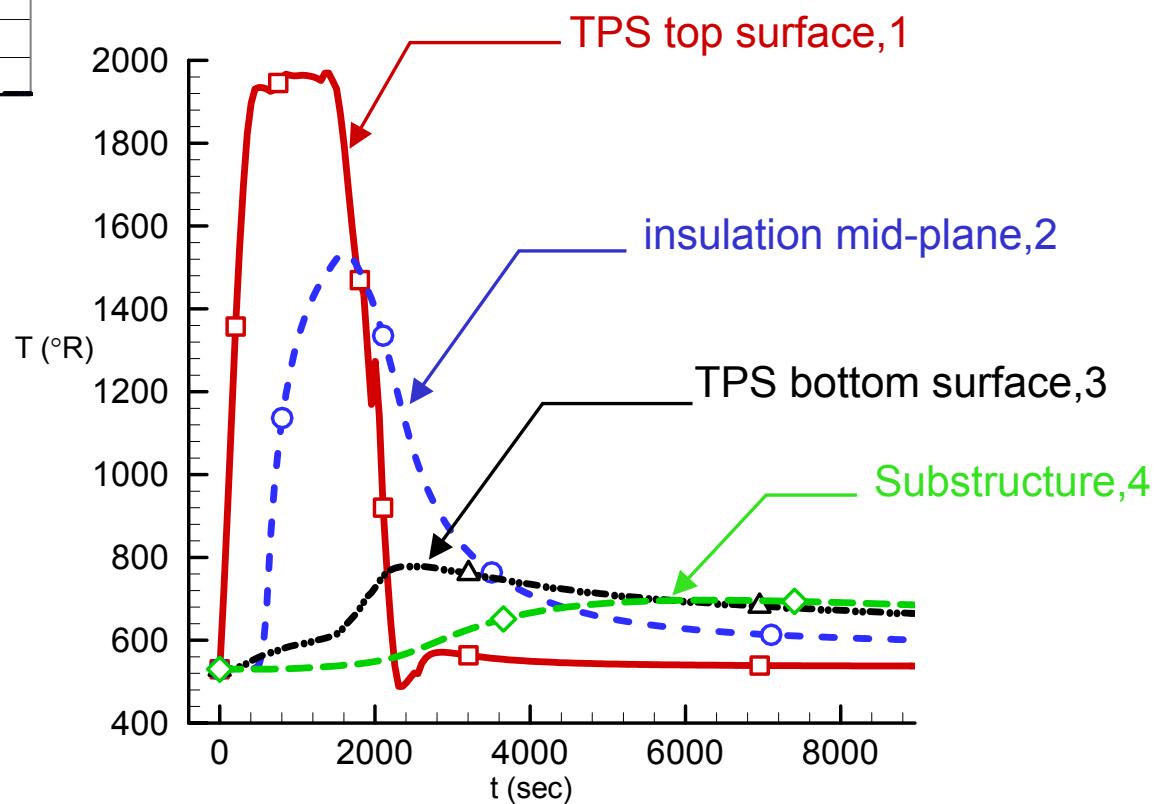
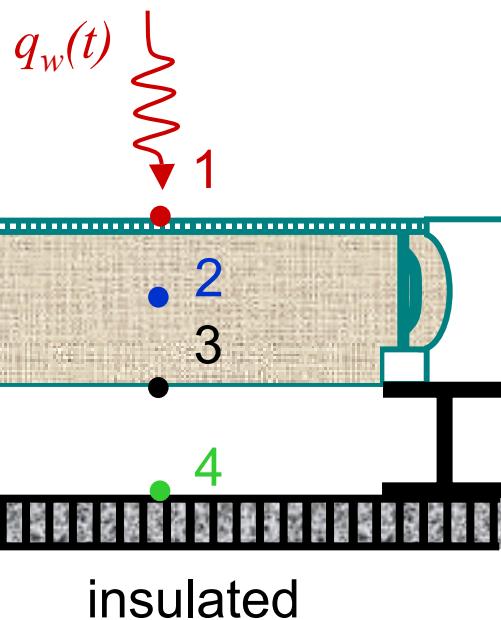
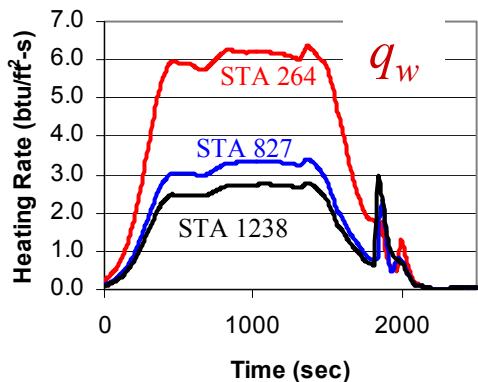
Through-the-Thickness Plug Models are Adequate for Insulated Structures since In-plane Temperature Gradients are Small

Through-the-Thickness Plug Model of Complex Metallic TPS Concept

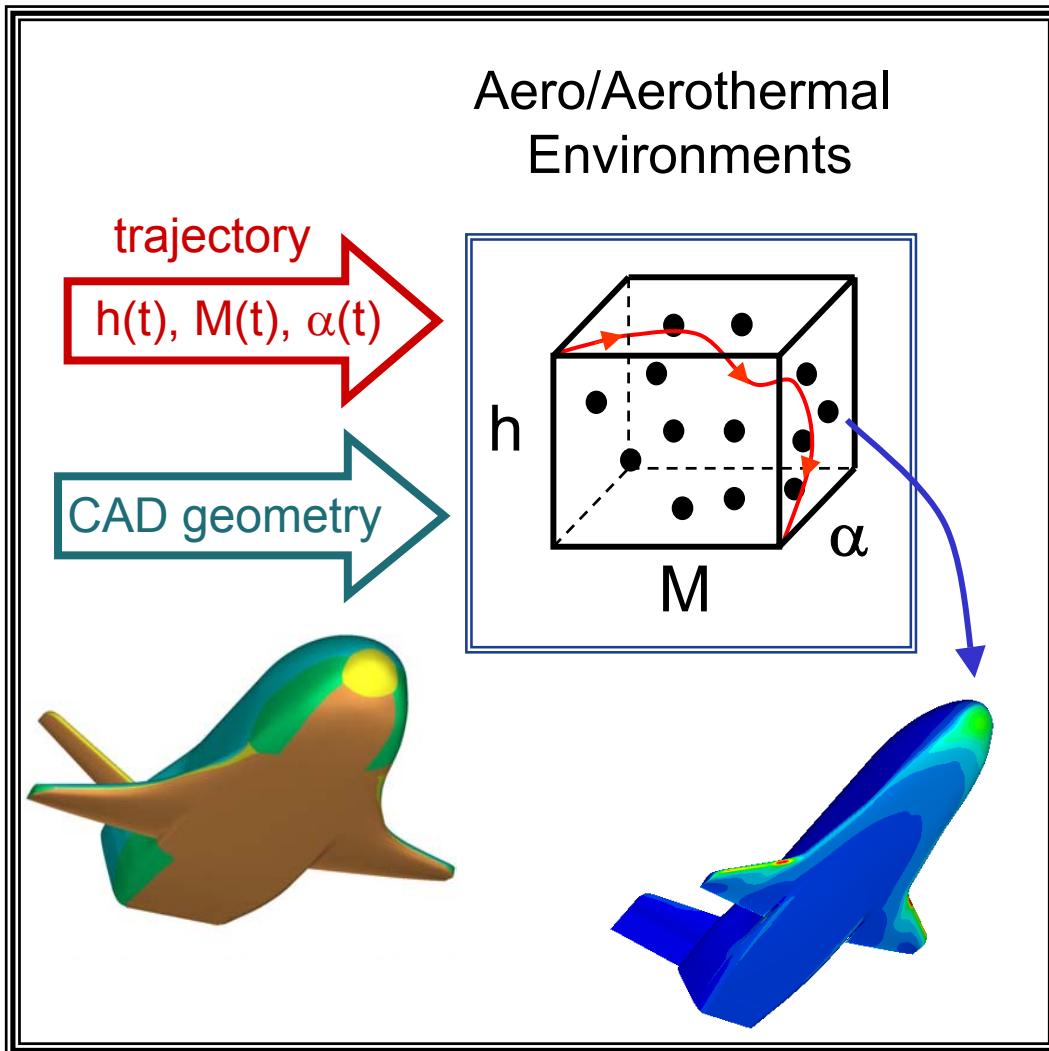
Armor TPS panel



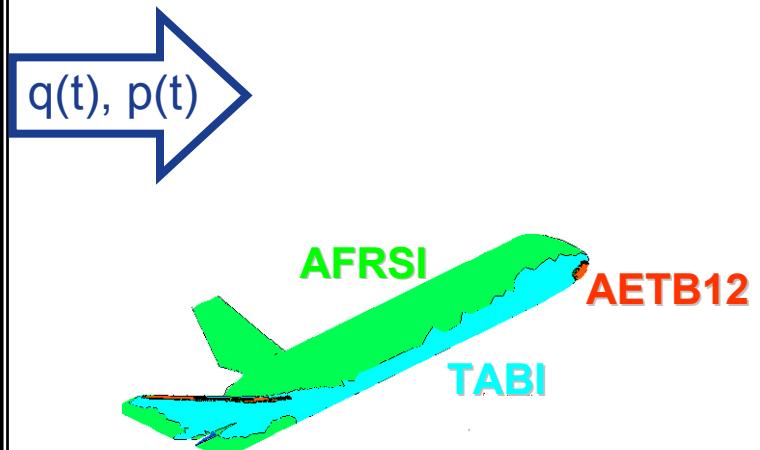
Thermal Response Predicted with TPS-it



Decoupled CFD-Thermal Interactions Simplify the Design Process



TPS Sizing and Material Selection



CFD-Thermal Interactions for Hot (non-insulated) Structures are Coupled

Structure absorbs thermal energy

- Heating strongly depends on wall temperature

$$q_{aero} = -k_f \frac{\partial T_f}{\partial z} = q_{aero}(T_W)$$

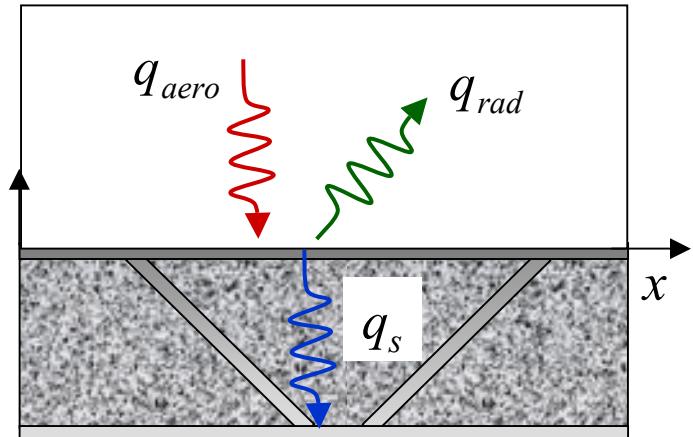
- Wall temperature strongly depends on thermal energy absorbed by structure $T_W = T_W(q_s)$

At the fluid-solid interface

$$\left. \begin{aligned} -k_f \frac{\partial T_f}{\partial z} &= k_s \frac{\partial T_s}{\partial z} = q_W \\ T_f &= T_s = T_W \end{aligned} \right\}$$

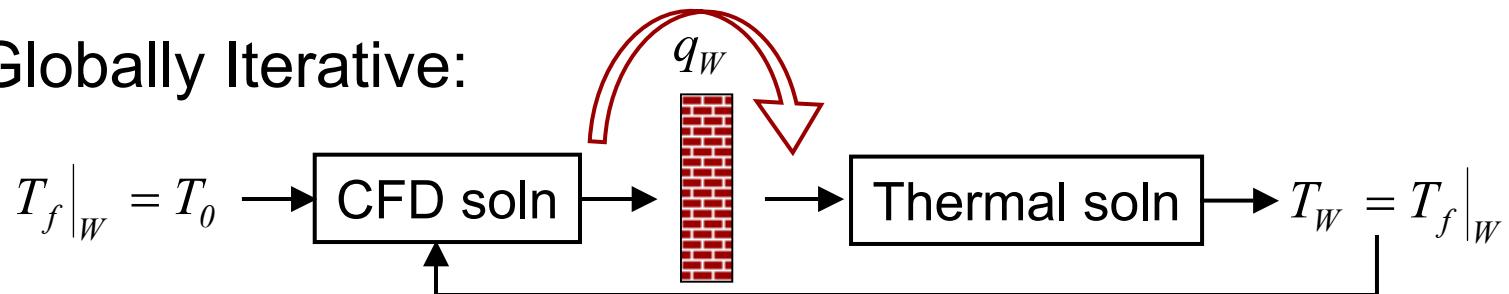
Fluid: k_f, T_f

Solid: k_s, T_s

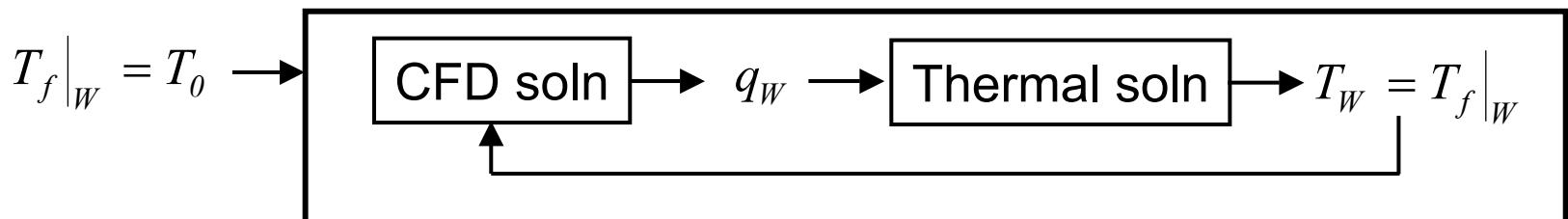


CFD-Thermal Coupling Approaches

Globally Iterative:



Locally iterative:



Fully Coupled:

- Solid is a fluid with $u=v=w=0$
- Cast thermal problem in conservation form, use same CFD algorithm, coupled energy equation at interface

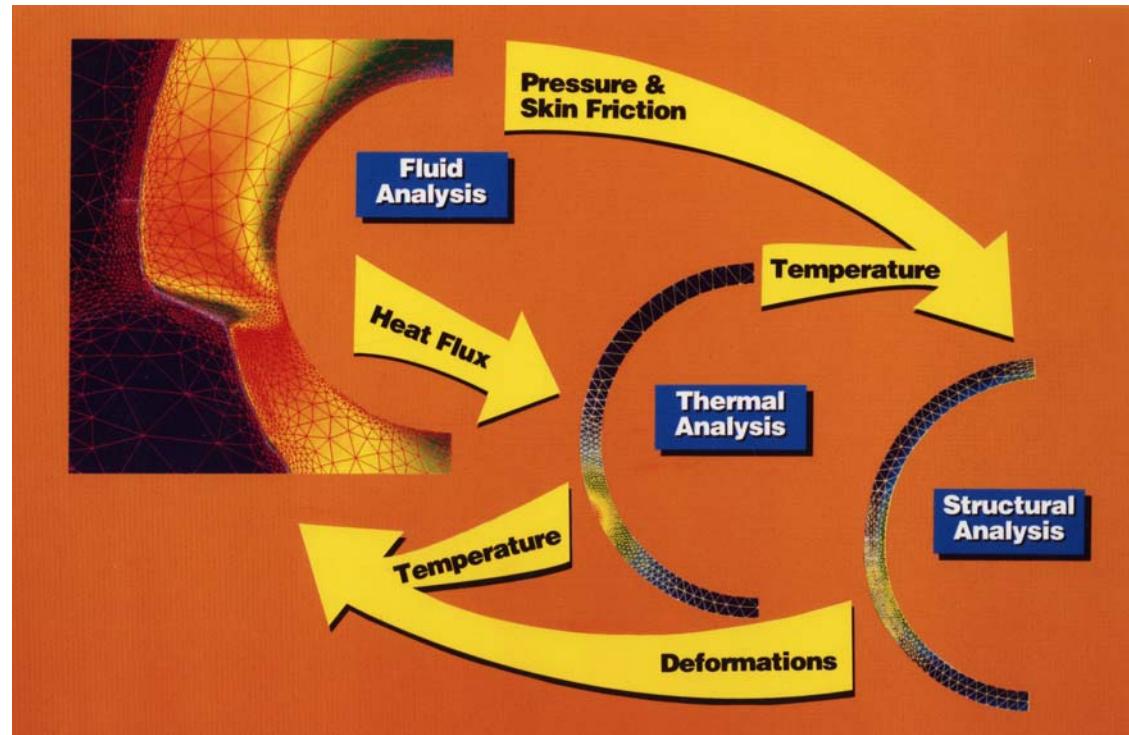
$$\begin{bmatrix} \text{[]} & \text{[]} \\ \text{[]} & \text{[]} \end{bmatrix} \begin{bmatrix} u \\ R \end{bmatrix} = \begin{bmatrix} \text{[]} & \text{[]} \\ \text{[]} & \text{[]} \end{bmatrix}$$

Integrated Fluid-Thermal-Structural Analysis using Unstructured Meshes

Fully coupled analysis using Taylor-Galerkin finite element formulation

- artificial viscosity for high speed flow
- flux-based formulation for heat transfer

Structural analysis of built-up structures rarely use meshes of the “continuum” (3D elasticity equations).



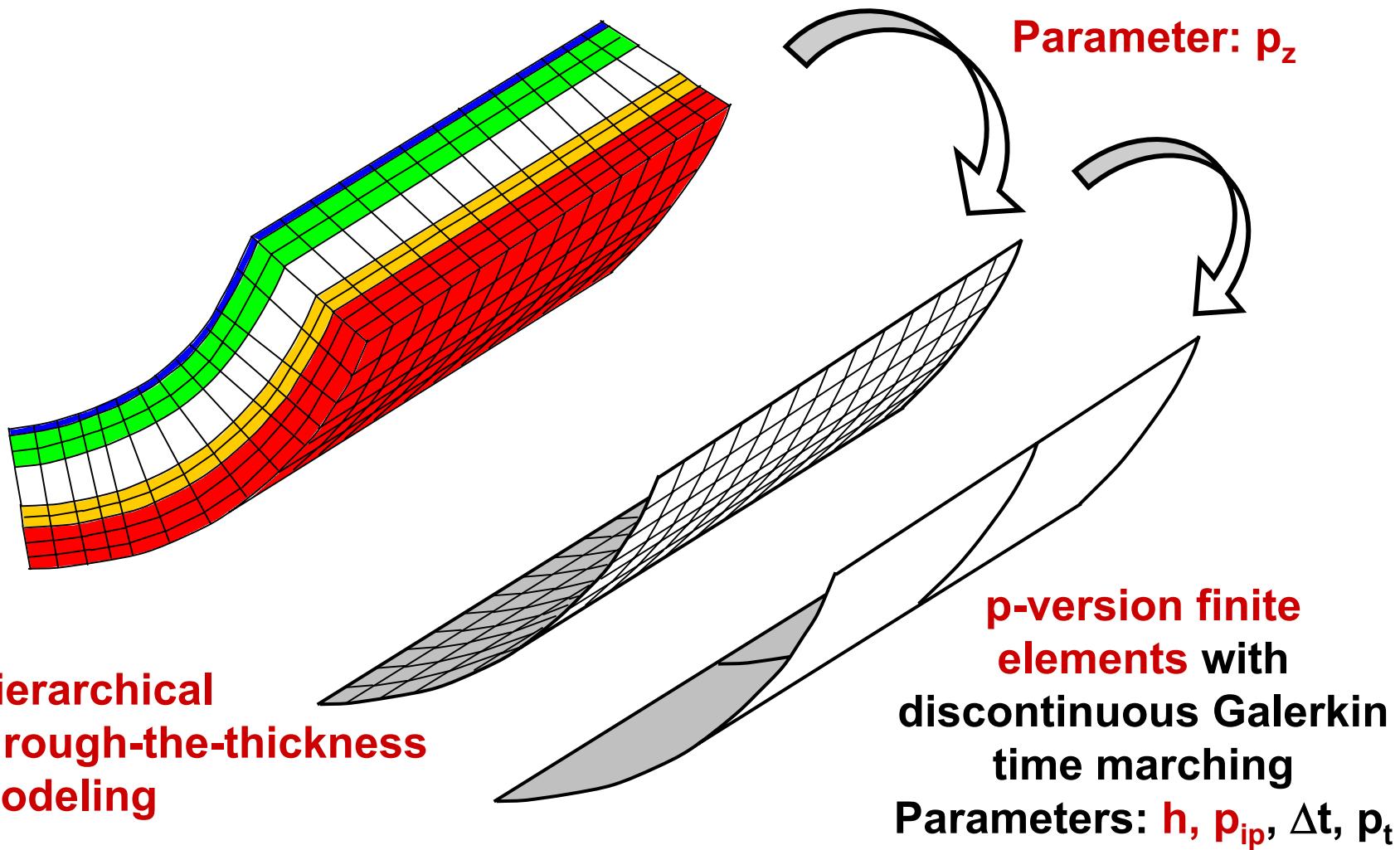
Dechaumphai et. al. LaRC, Circa 1990

Built-up structures are “modeled” with plates, shells, beams, and 3D elements.

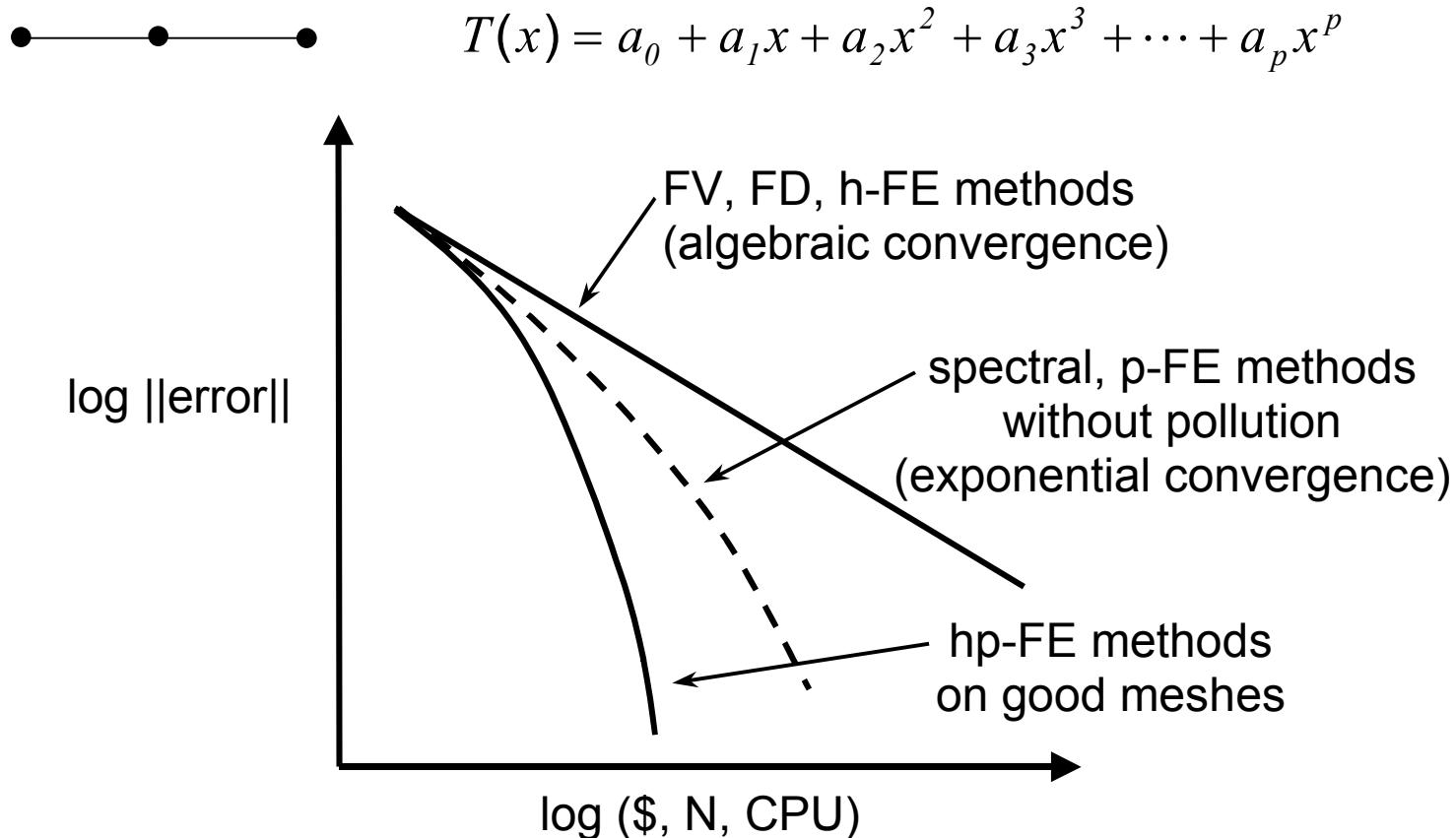


Need thermal analogues

“Next Generation” Thermal Analysis Methods for Hot Built-up Structures



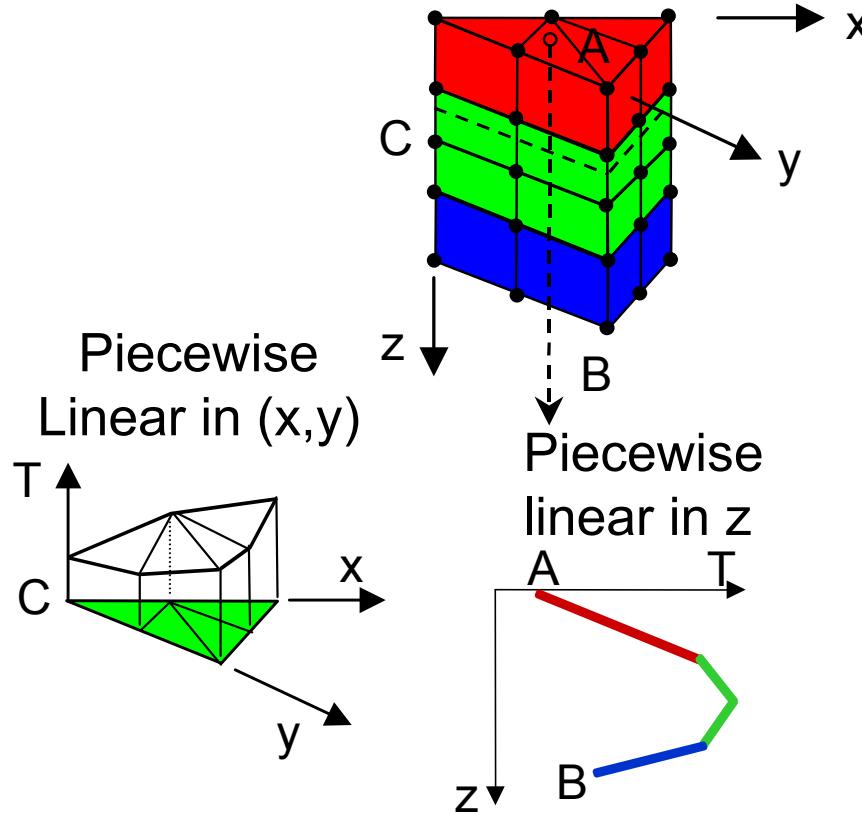
Why p-Version Finite Elements?



Higher accuracy for fixed number of unknowns
Fewer elements for fixed accuracy
Element shapes that reflect actual geometry

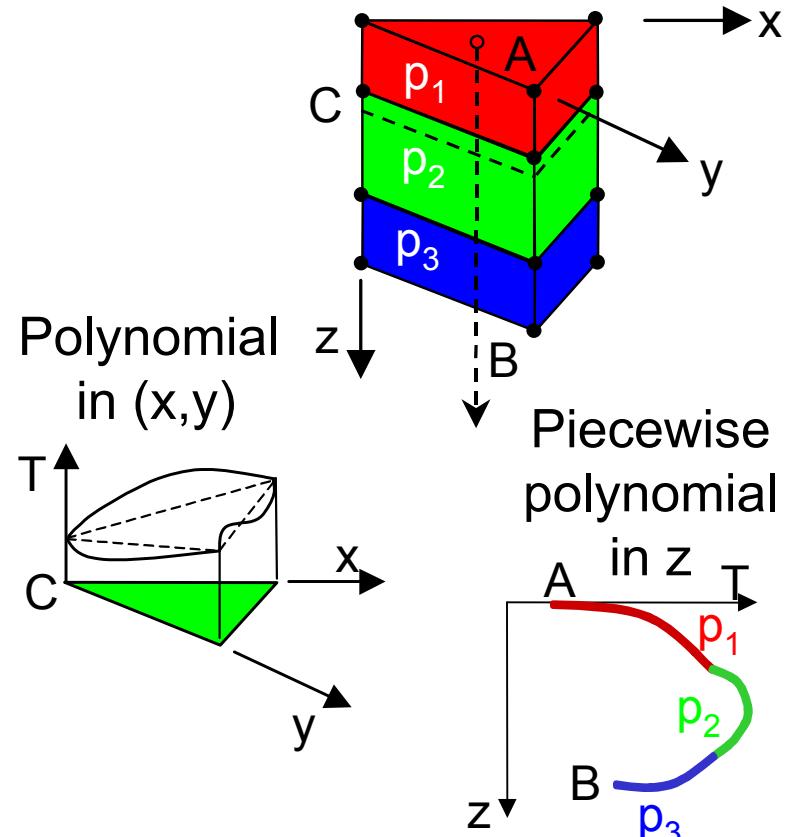
Finite Element Options for Multi-layered Plates

Conventional elements ($p=1$)



Improve accuracy by adding more elements

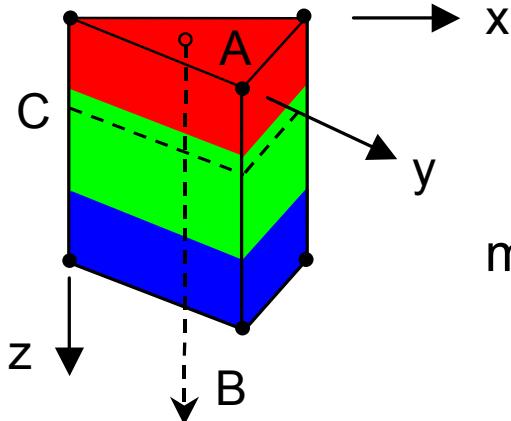
p -Version elements



Improve accuracy by increasing polynomial degree

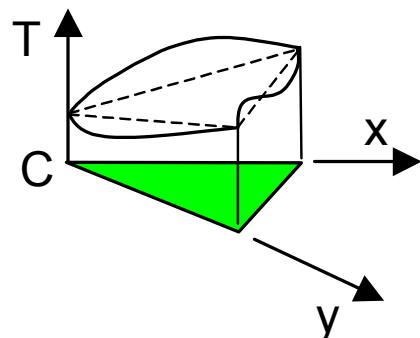
Homogenized Through-the-Thickness Modeling of Conduction in Multi-layered Plates

p-element

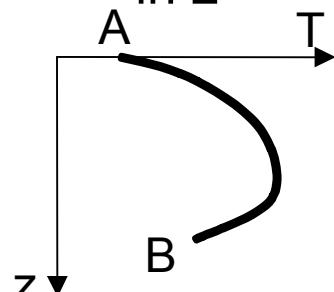


mathematically equivalent

Polynomial
in (x,y)

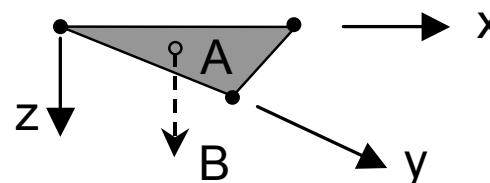


Single
polynomial
in z



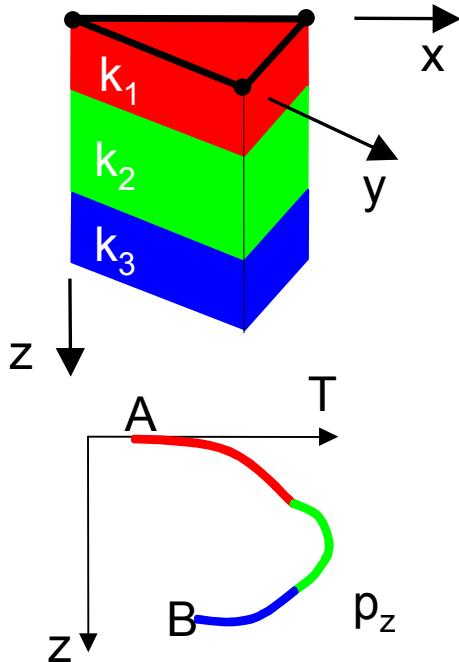
Hierarchical model

- Geometrically collapsed
- Thermal “higher-order plate theory”
- Structurally compatible



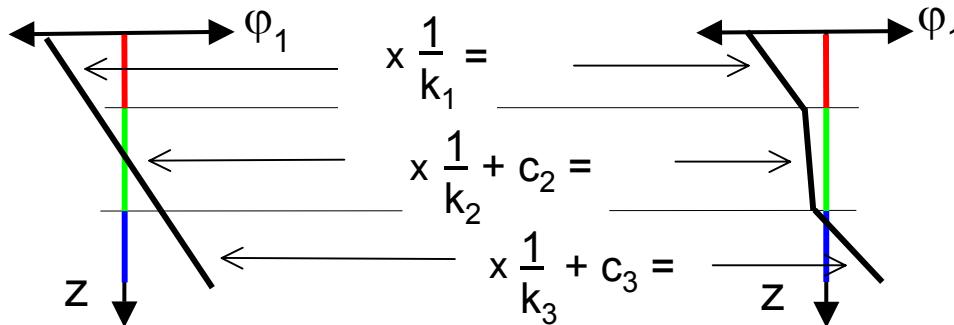
- + Fewer degrees of freedom than multiple layers of p-elements
- + Good for single-layer
- Bad for multiple layers
 - Lacks convergence with increasing model order
 - Jump in the flux across material interfaces

Optimal Through-the-Thickness Modeling of Conduction in Multi-layered Plates



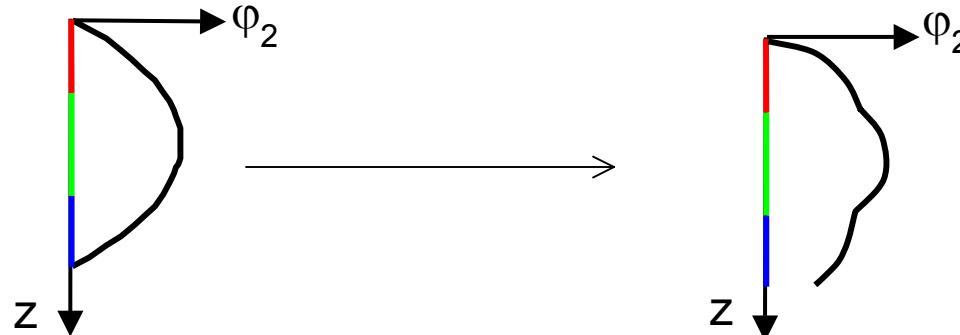
Basis functions are single polynomials defined piecewise by scaling the homogenized basis functions by the thermal conductivity of each layer

Homogenized basis functions

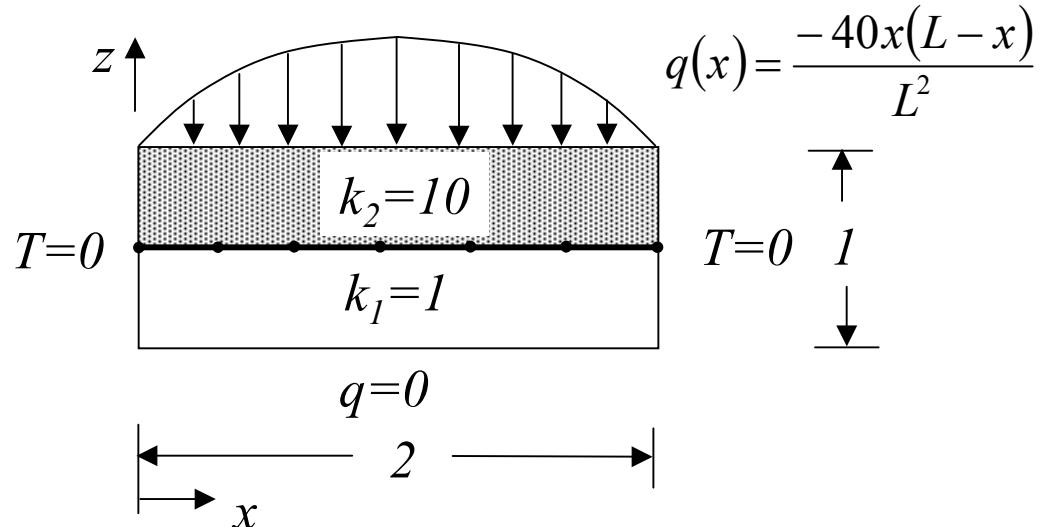


Same number of DOF's as homogenized hierarchical model

Converges with model order and plate thickness

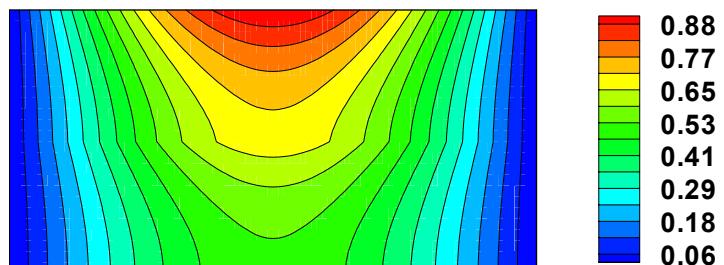


Steady-State Conduction in a Two-Layer Plate

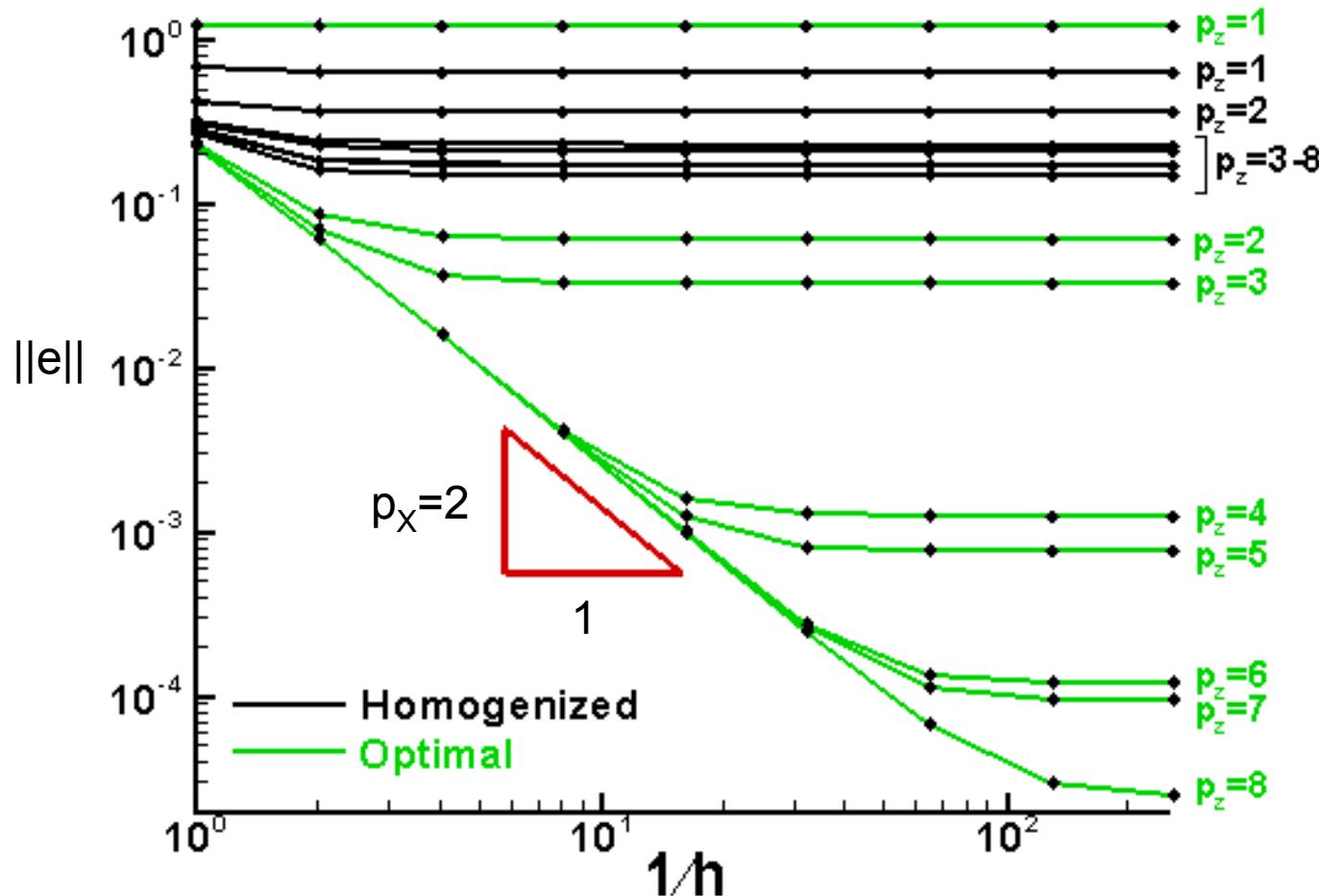


Exact Solution

$$T = \sum_{n=1}^{\infty} \sin\left(\frac{n\pi x}{L}\right) \begin{cases} A_n \sinh\left(\frac{n\pi z}{L}\right) + B_n \cosh\left(\frac{n\pi z}{L}\right) \\ C_n \sinh\left(\frac{n\pi z}{L}\right) + D_n \cosh\left(\frac{n\pi z}{L}\right) \end{cases}$$



Convergence of Through-the-Thickness Hierarchical Models of Conduction in Two-Layer Plate



A Posteriori Error Estimation

- Error in finite element solution $e = u - \hat{u}$
- Global error equation

$$\begin{aligned} -\nabla \cdot (\kappa \nabla u) &= Q \\ +\nabla \cdot (\kappa \nabla \hat{u}) -\nabla \cdot (\kappa \nabla u) &= Q + \nabla \cdot (\kappa \nabla \hat{u}) \\ -\nabla \cdot (\kappa \nabla e) &= Q + \nabla \cdot (\kappa \nabla \hat{u}) \end{aligned}$$

- Can solve this global problem using the same FE approach, but this would be as computationally expensive as obtaining the solution
- Instead, solve a local problem on each element

$$-\int_K \nabla \cdot (\kappa \nabla e) v \, d\Omega = \int_K Q v \, d\Omega + \int_K \nabla \cdot (\kappa \nabla \hat{u}) v \, d\Omega$$

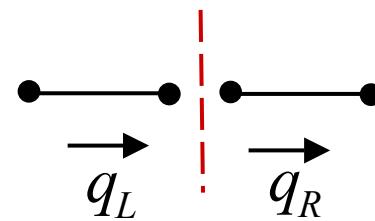
Local Problem for Element Error

- Weak formulation of element error problem

$$\int_K (\kappa \nabla e) \cdot \nabla v d\Omega = \int_K Q v d\Omega - \int_K (\kappa \nabla \hat{u}) \cdot \nabla v d\Omega + \int_{\partial K} (\kappa \nabla u) \cdot \vec{n} v ds$$

- Approximate boundary flux $\hat{q} = \bar{q} + \tilde{q}$ q is unknown

\bar{q} = Average flux



\tilde{q} = Correction to equilibrate \hat{q}

Find \tilde{q}_K = polynomial of degree p_z such that

$$\int_{\partial K} \tilde{q}_K \theta_n ds = \int_K (\kappa \nabla \hat{u}) \cdot \nabla \theta_n d\Omega - \int_K Q \theta_n d\Omega - \int_{\partial K} \bar{q}_K \theta_n ds$$

θ_n = nodal basis functions , $n = 1, \dots, p_z$

$$[M]\{\tilde{q}\} = \{R\}$$

Ref: Ainsworth & Oden

On Each Element, Solve the Local Problem for the Estimated Error

- Approximate element error

Find $\hat{e} = \sum_{i=0}^{p_x+1} \sum_{j=0}^{p_z+1} \varphi_i(x) \psi_j(z) \varepsilon_{ij}$ such that

$$\int_K (\kappa \nabla \hat{e}) \cdot \nabla v d\Omega = \int_K Q v d\Omega - \int_K (\kappa \nabla \hat{u}) \cdot \nabla v d\Omega + \int_{\partial K} \hat{q} v ds$$

for all admissible v

$$[K]\{e\} = \{F\}$$

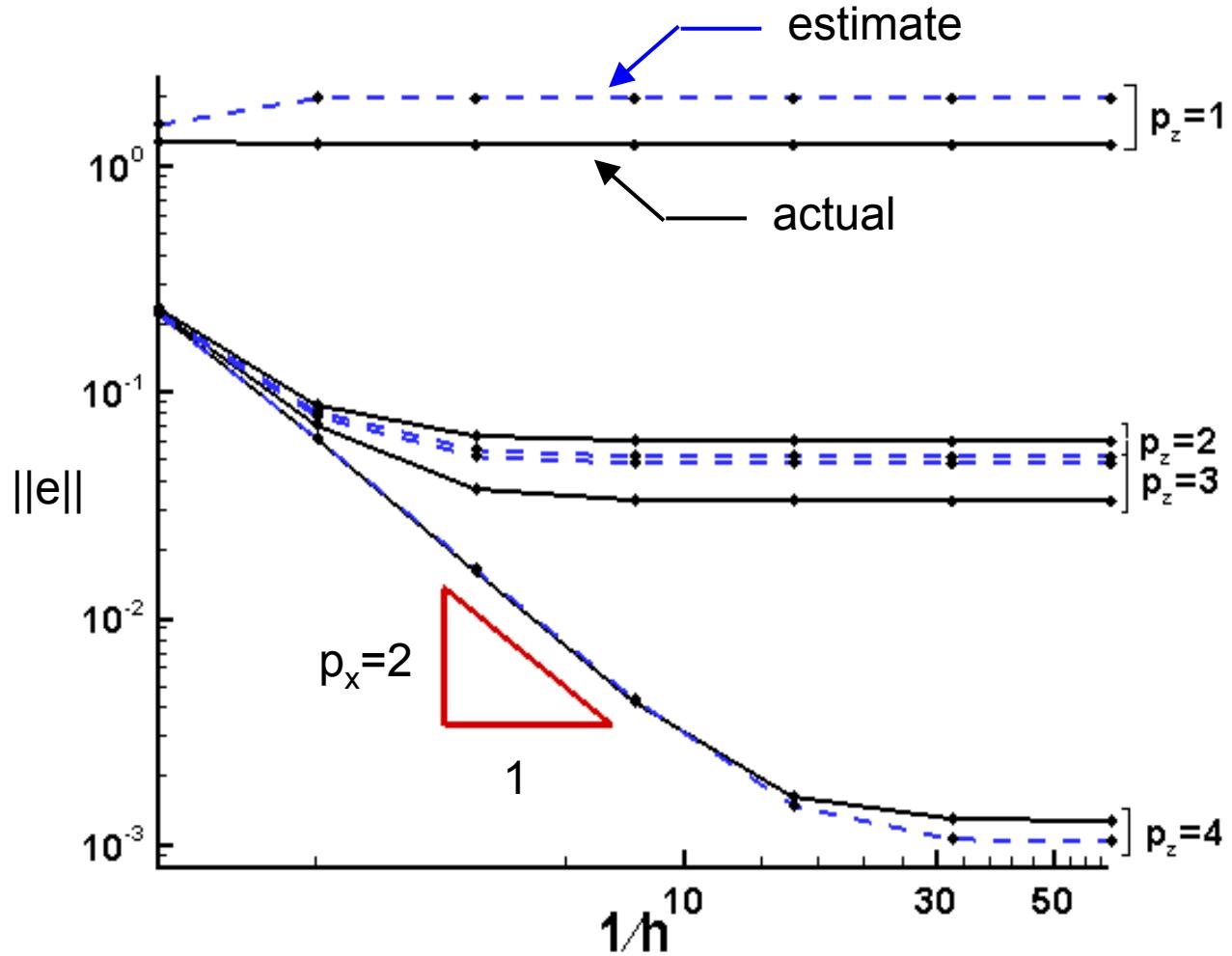
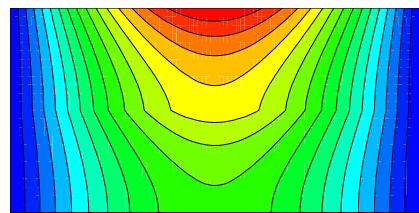
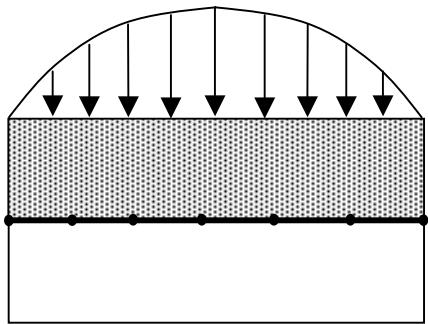
- Element error indicator

$$\| \hat{e} \|_K = \sqrt{\int_K (\kappa \nabla \hat{e}) \cdot \nabla \hat{e} d\Omega}$$

- Global error estimate

$$\| \hat{e} \|_\Omega = \sqrt{\sum_K \| \hat{e} \|_K^2}$$

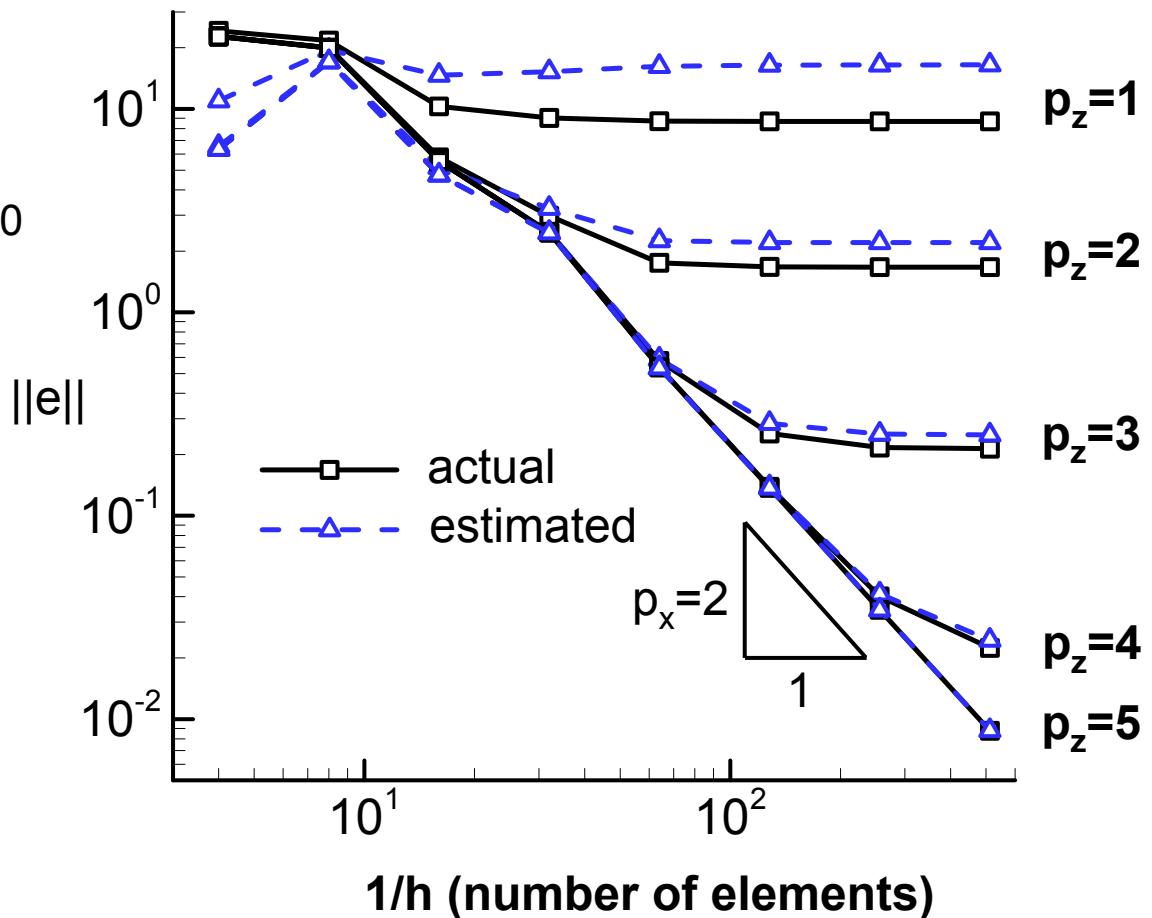
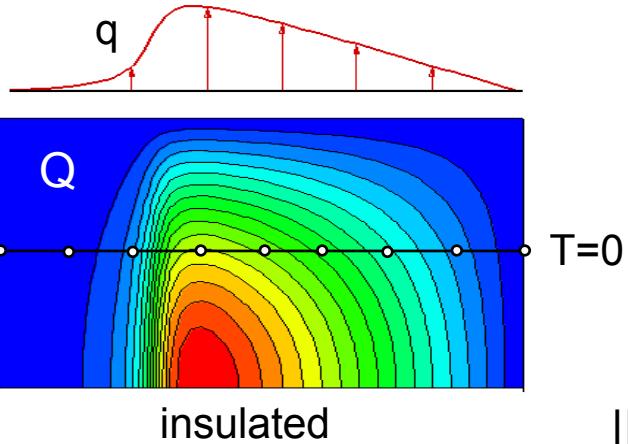
Performance of the Error Estimate on the Two-Layer Example



Performance of Error Estimate

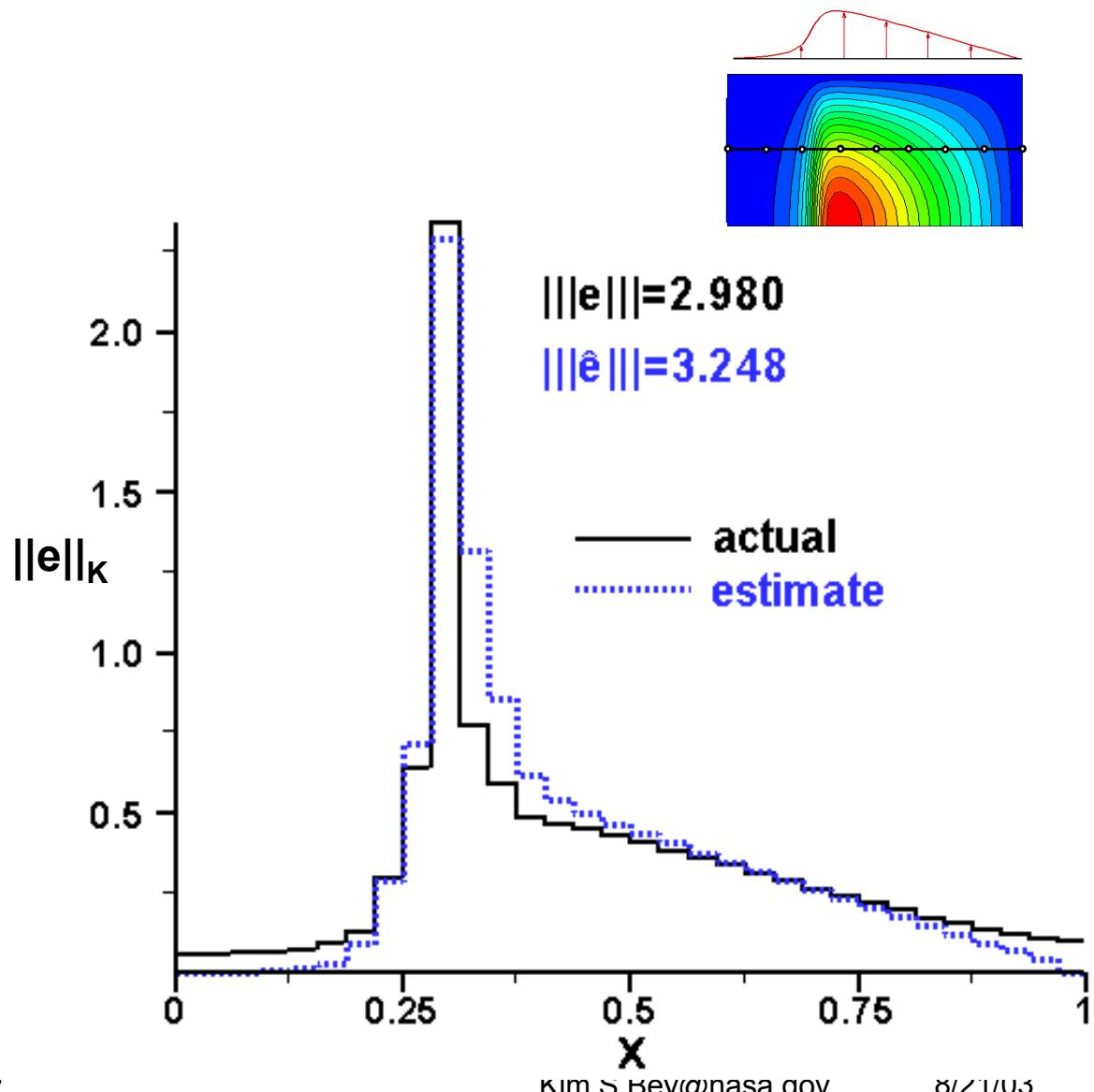
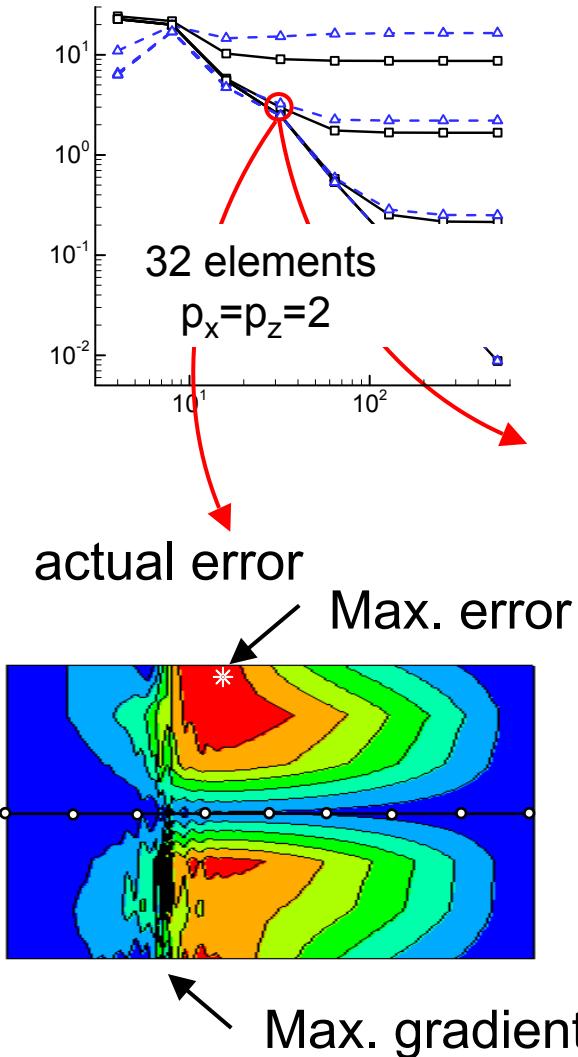
Steady Conduction with Internal Heat Generation

Rough Exact Solution



Performance of Element Error Indicator

Steady Conduction with Internal Heat Generation



Estimating Contributions of Hierarchical Modeling and Finite Element Error

- Hierarchical modeling error: $e_{HM} = u - u_{HM}$
- Finite element error: $e_{FE} = u_{HM} - \hat{u}$
- Total error: $e = u - \hat{u} = e_{HM} + e_{FE}$

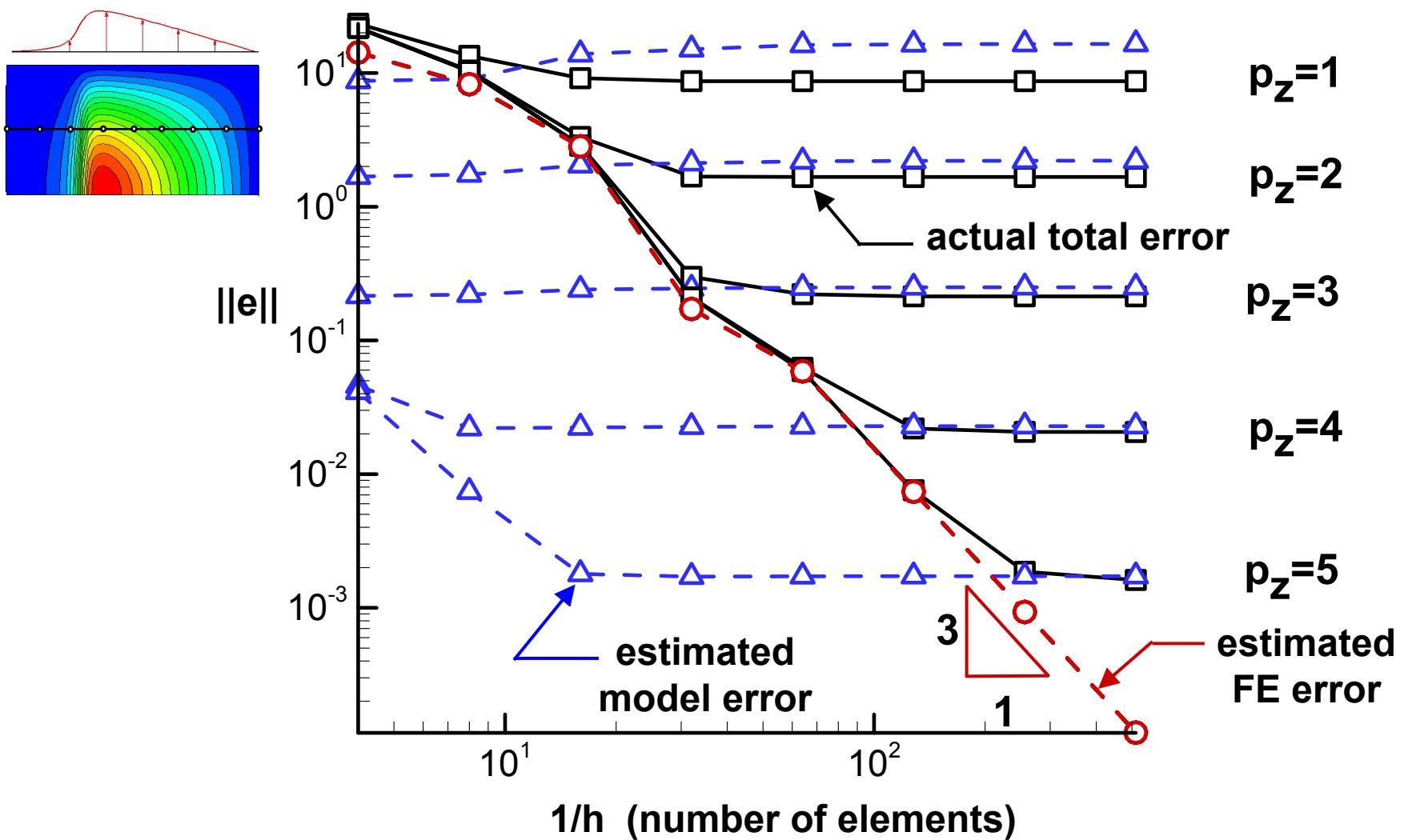
$$\|e\|^2 = \|e_{HM}\|^2 + \|e_{FE}\|^2$$

- Solve local problem twice

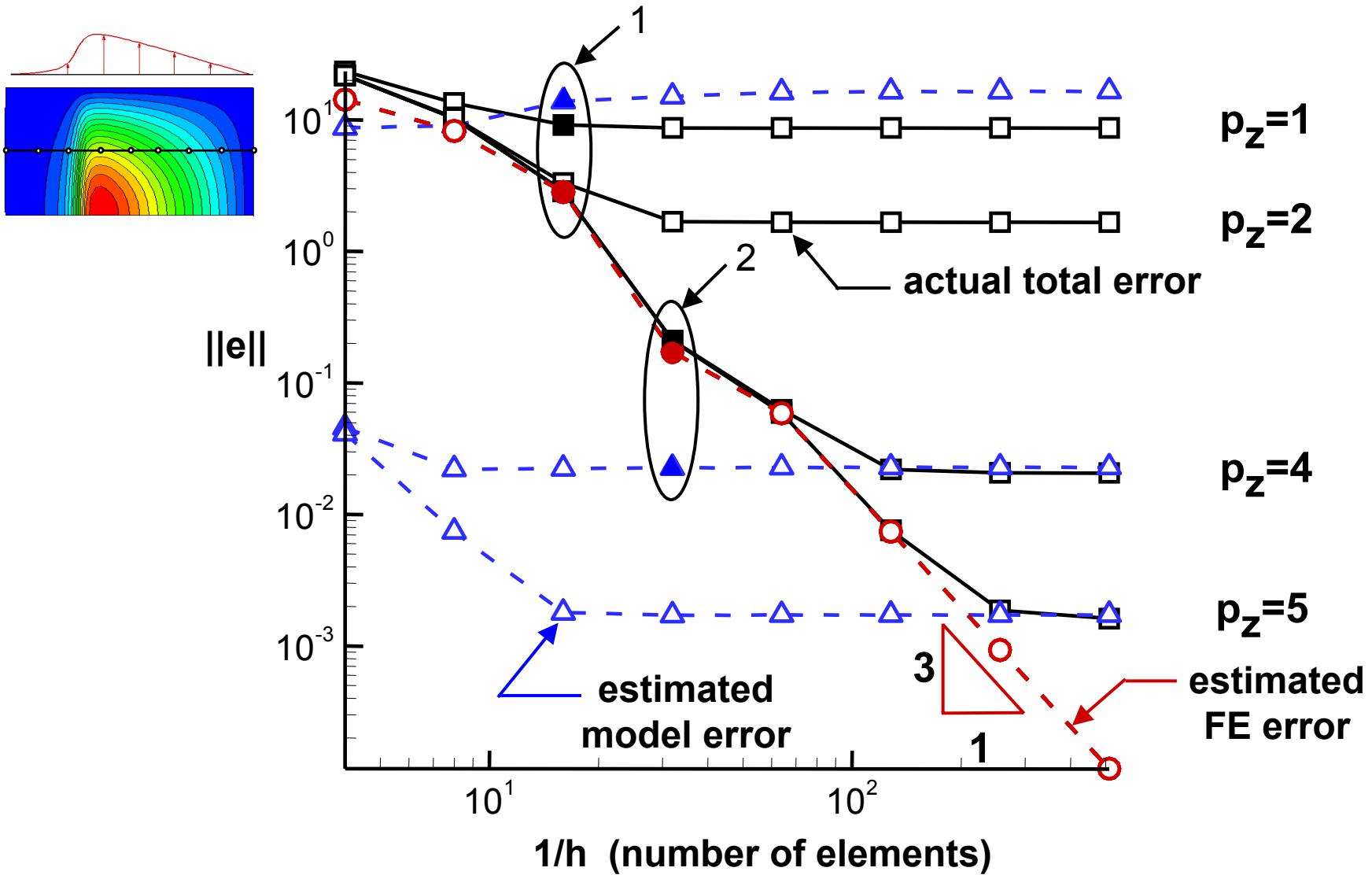
$$\hat{e}_{HM} = \sum_{i=0}^{p_x} \sum_{j=0}^{p_z+1} \varphi_i(x) \psi_j(z) c_{ij}$$

$$\hat{e}_{FE} = \sum_{i=0}^{p_x+1} \sum_{j=0}^{p_z} \varphi_i(x) \psi_j(z) d_{ij}$$

Performance of Estimated Error Contributions



Error Estimates are Sufficiently Accurate to Drive an Adaptive Strategy



Concluding Remarks

- Examples shown here were constructed to have exact solutions to study behavior of the solution method and error estimates.
- Similar approach has been used with same success for transient 3D linear conduction using 2D elements and steady-state 3D nonlinear conduction.
- Can homogenization using p-version finite elements be used to accurately represent the thermal effects of all the internal structure on the surface?